# **bq27441-G1**

# **Technical Reference**



Literature Number: SLUUAC9 December 2013



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## *Preface*

This document is a detailed Technical Reference Manual (TRM) for using and configuring the bq27441-G1 battery fuel gauge. This TRM document is intended to complement but not supersede any information contained in the separate bq27441-G1 datasheet. Refer to the [bq27441-G1](http://www.ti.com/lit/pdf/SLUSBH1) Datasheet (SLUSBH1).

Another useful reference document is the [bq27441-G1](http://www.ti.com/lit/pdf/SLUUAP7) Quick Start Guide (SLUUAP7).

#### **Formatting Conventions used in this Document:**



#### **Revision History**



Impedance Track is a trademark of Texas Instruments.

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## *General Description*

The bq27441-G1 battery fuel gauge accurately predicts the battery capacity and other operational characteristics of a single Li-based rechargeable cell. It can be interrogated by a system processor to provide cell information, such as state-of-charge (SOC). The device is orderable in two pre-defined standard configurations:

- bq27441-G1A is pre-defined for LiCoO<sub>2</sub>-based batteries for 4.2 V max charge voltage.
- bq27441-G1B is pre-defined for LiMn<sub>2</sub>O<sub>4</sub>-based batteries for 4.3 V or 4.35 V max charge voltages.

Unlike some other Impedance Track™ fuel gauges, the bq27441-G1 can not be programmed with specific battery chemistry profiles. For many battery types and applications, the pre-defined standard chemistry profiles available in the bq27441-G1A or bq27441-G1B are sufficient matches from a gauging perspective.

Information is accessed through a series of commands, called *Standard Commands*. Further capabilities are provided by the additional *Extended Commands* set. Both sets of commands, indicated by the general format *Command( )*, are used to read and write information contained within the bq27441-G1 control and status registers, as well as its data locations. Commands are sent from system to gauge using the bq27441-G1's I<sup>2</sup>C serial communications engine, and can be executed during application development, system manufacture, or end-equipment operation.

The key to the bq27441-G1's high-accuracy fuel gauging prediction is TI's proprietary Impedance Track algorithm. This algorithm uses cell measurements, characteristics, and properties to create state-of-charge predictions that can achieve high accuracy across a wide variety of operating conditions and over the lifetime of the battery.

The bq27441-G1 measures charge and discharge activity by monitoring the voltage across a small-value external sense resistor. Cell impedance is computed based on current, open-circuit voltage (OCV), and cell voltage under loading conditions.

The bq27441-G1 uses an integrated temperature sensor for estimating cell temperature. Alternatively, the system processor can provide temperature data for the bq27441-G1.

To minimize power consumption, the bq27441-G1 has several power modes: INITIALIZATION, NORMAL, SLEEP, HIBERNATE and SHUTDOWN. The bq27441-G1 passes automatically between these modes, depending upon the occurrence of specific events, though a system processor can initiate some of these modes directly.

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## *Functional Description*

#### <span id="page-5-1"></span>**2.1 Fuel Gauging**

The bq27441-G1 battery fuel gauge measures the cell voltage, temperature, and current to determine battery SOC. The fuel gauge monitors charge and discharge activity by sensing the voltage across a small-value external sense resistor (10 m $\Omega$ , typical) between the BAT and SRX pins. By integrating the charge passing through the battery, the battery SOC is adjusted during battery charge or discharge.

The total battery capacity is found by comparing states of charge before and after applying the load with the amount of charge passed. When an application load is applied, the impedance of the cell is measured by comparing the OCV obtained from a predefined function for present SOC with the measured voltage under load. Measurements of OCV and charge integration determine chemical state of charge and chemical capacity (Qmax). The initial value for Qmax is defined by *Design Capacity* and should match the cell manufacturers' data sheet. The fuel gauge acquires and updates the battery-impedance profile during normal battery usage. The impedance profile, along with SOC and the Qmax value, are used to determine *FullChargeCapacity( )* and *StateOfCharge( )*, specifically for the present load and temperature. *FullChargeCapacity( )* is reported as capacity available from a fully-charged battery under the present load and temperature until *Voltage( )* reaches the *Terminate Voltage*. *NominalAvailableCapacity( )* and *FullAvailableCapacity( )* are the uncompensated (no or light load) versions of *RemainingCapacity( )* and *FullChargeCapacity( )*, respectively.

The bq27441-G1 has two flags, [SOC1] and [SOCF], accessed by the *Flags( )* command that warns when the battery SOC has fallen to critical levels. When *RemainingCapacity( )* falls below the first capacity threshold, specified in *SOC1 Set Threshold*, the [SOC1] (state of charge initial) flag is set. The flag is cleared once *RemainingCapacity( )* rises above *SOC1 Set Threshold*. All units are in mAh.

When *RemainingCapacity( )* falls below the second capacity threshold, *SOCF Set Threshold*, the [SOCF] (state of charge final) flag is set, serving as a final discharge warning. If *SOCF Set Threshold* = –1, the flag is inoperative during discharge. Similarly, when *RemainingCapacity( )* rises above *SOCF Clear Threshold* and the [SOCF] flag has already been set, the [SOCF] flag is cleared. All units are in mAh.

#### <span id="page-5-2"></span>**2.2 Temperature Measurement**

The fuel gauge measures temperature via its internal on-chip sensor. This internal temperature data will be used for the data for Impedance Track algorithm purposes if the *OpConfig [TEMPS]* bit is cleared. Alternatively, if the *OpConfig [TEMPS]* bit is set, the system processor can set the temperature for the fuel gauging algorithm.

Regardless of which sensor is used for measurement, the system processor can request the current battery temperature by calling the *Temperature( )* function.

#### <span id="page-5-3"></span>**2.3 Current Measurement**

The fuel gauge measures current by sensing the voltage across a small-value external resistor (10 m $\Omega$ , typical) between the BAT and SRX pins. Internally, voltage passes through a gain stage before conversion by the coulomb counter. The current measurement data is available via the *AverageCurrent( )* command.



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#### <span id="page-6-0"></span>**2.4 OPERATING MODES**

execute any allowable task. Configuration data in RAM can be updated by the host using the CONFIG UPDATE mode. In SLEEP mode the fuel gauge turns off the high frequency oscillator clock to enter a reduced-power state, periodically taking measurements and performing calculations. In HIBERNATE mode the bq27441-G1 is in a very low power state, but can be woken up by communication or certain I/O activity.

### *2.4.1 SHUTDOWN Mode*

In SHUTDOWN mode, the LDO output is disabled so internal power and all RAM-based volatile data is lost. Since no gauging occurs in SHUTDOWN mode, additional gauging error can be introduced if the system has significant battery charge and discharge activity prior to re-INITIALIZATION. The host can command the gauge to immediately enter SHUTDOWN mode by first enabling the mode with a SHUTDOWN\_ENABLE subcommand [\(Section](#page-14-6) 4.1.12) followed by the SHUTDOWN subcommand [\(Section](#page-14-7) 4.1.13). To exit SHUTDOWN mode, a rising edge on the GPOUT pin from logic low to logic high is required.

### <span id="page-6-1"></span>*2.4.2 POR and INITIALIZATION Modes*

Upon POR, the fuel gauge copies ROM-based configuration defaults to RAM and begins INITIALIZATION mode where essential data is initialized and will remain in INITIALIZATION mode as halted-CPU state when an adapter, or other power source is present to power the bq27441-G1 (and system), yet no battery has been detected. The occurrence of POR or a *Control( )* RESET subcommand will set the Flags*( )* [ITPOR] status bit to indicate that RAM has returned to ROM default data. When battery insertion is detected, a series of initialization activities begin including an OCV measurement. In addition CONTROL\_STATUS[*QMAX\_UP*] and [*RES\_UP*] bits are cleared to allow fast learning of Qmax and impedance.

Some commands, issued by a system processor, can be processed while the fuel gauge is halted in this mode. The gauge will wake up to process the command, and then return to the halted state awaiting battery insertion. The current consumption of INITIALIZATION mode is similar to NORMAL mode.

### <span id="page-6-2"></span>*2.4.3 CONFIG UPDATE Mode*

If the application requires different configuration data for the fuel gauge, the system processor can update RAM-based Data Memory parameters using the *Control( )* SET\_CFGUPDATE subcommand to enter CONFIG UPDATE mode as indicated by the *Flags( )* [CFGUPMODE] status bit. In this mode, fuel gauging is suspended while the host uses the Extended Data Commands to modify the configuration data blocks. To resume fuel gauging, the host sends a *Control( )* SOFT\_RESETsubcommand to exit CONFIG UPDATE mode and clear both *Flags( )* [ITPOR] and [CFGUPMODE] bits. After a timeout of approximately 240 seconds (4 minutes), the gauge will automatically exit CONFIG UPDATE mode if it has not received a SOFT\_RESET subcommand from the host.

### *2.4.4 NORMAL Mode*

The fuel gauge is in NORMAL mode when not in any other power mode. During this mode, *AverageCurrent( )*, *Voltage( )* and *Temperature( )* measurements are taken once per second, and the interface data set is updated. Decisions to change states are also made. This mode is exited by activating a different power mode.

Because the gauge consumes the most power in NORMAL mode, the Impedance Track algorithm minimizes the time the fuel gauge remains in this mode.



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#### <span id="page-7-0"></span>*2.4.5 SLEEP Mode*

SLEEP mode is entered automatically if the feature is enabled (*OpConfig[SLEEP]*) = 1) and *AverageCurrent( )* is below the programmable level *Sleep Current* (default = 10 mA). Once entry into SLEEP mode has been qualified, but prior to entering it, the fuel gauge performs an ADC autocalibration to minimize offset.

During SLEEP mode, the fuel gauge remains in a very low power idle state and automatically wakes up briefly every 20 seconds to take data measurements.

After making the measurements on the 20 second interval, the fuel gauge will exit SLEEP mode when *AverageCurrent( )* rises above *Sleep Current* (default = 10mA). Alternatively, an early wake-up before the 20 second internal is possible if the instantaneous current is detected by an internal hardware comparator above an approximate threshold of ±30 mA.

#### <span id="page-7-1"></span>*2.4.6 HIBERNATE Mode*

HIBERNATE mode could be used when the system equipment needs to enter a very low-power state, and minimal gauge power consumption is required. This mode is ideal when a system equipment is set to its own HIBERNATE, SHUTDOWN, or OFF modes.

Before the fuel gauge can enter HIBERNATE mode, the system must set the *[HIBERNATE]* bit of the CONTROL\_STATUS register. The gauge waits to enter HIBERNATE mode until it has taken a valid OCV measurement and the magnitude of the average cell current has fallen below *Hibernate Current*. The gauge can also enter HIBERNATE mode if the cell voltage falls below the *Hibernate Voltage*. The gauge will remain in HIBERNATE mode until the system issues a direct  $I^2C$  command to the gauge. I<sup>2</sup>C communication that is not directed to the gauge will only briefly wake it up and the gauge immediately returns to HIBERNATE mode.

It is the system's responsibility to wake the fuel gauge after it has gone into HIBERNATE mode and to prevent a charger from charging the battery before the [OCVTAKEN] bit is set which signals an OCV reading is taken. After waking, the gauge can proceed with the initialization of the battery information. During HIBERNATE mode, RAM-based data values are maintained, but gauging status is lost. Upon exit from HIBERNATE mode, the gauge will immediately re-acquire measurements and re-initialize all gauging predictions.





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<span id="page-8-0"></span>**Figure 2-1. Power Mode Diagram**

#### **2.5 Pin Descriptions**

#### <span id="page-9-0"></span>*2.5.1 GPOUT Pin*

The GPOUT pin is a multiplex pin and the polarity of the pin output can be selected via the *[GPIO\_POL]* bit of *OpConfig*. The function is defined by *[BATLOWEN]*. If set, the Battery Low Indicator (BAT\_LOW) function for the GPOUT pin is selected. If cleared, the SOC interrupt (SOC\_INT) function is selected for GPOUT.

When the BAT\_LOW function is activated, the signaling on the multiplexed pin follows the status of the *[SOC1]* bit in the *Flags( )* register. The bq27441-G1 has two flags accessed by the *Flags( )* function that warns when the battery's SOC has fallen to critical levels. When *StateOfCharge( )* falls below the first capacity threshold, specified in *SOC1 Set Threshold*, the *[SOC1] (State of Charge Initial)* flag is set. The flag is cleared once *StateOfCharge( )* rises above *SOC1 Set Threshold*. The bq27441-G1's GPOUT pin automatically reflects the status of the *[SOC1]* flag when *OpConfig[BATLOWEN=0]*.

When *StateOfCharge( )* falls below the second capacity threshold, *SOCF Set Threshold*, the *[SOCF] (State of Charge Final)* flag is set, serving as a final discharge warning. Similarly, when *StateOfCharge( )* rises above *SOCF Clear Threshold* and the *[SOCF]* flag has already been set, the *[SOCF]* flag is cleared.

When the SOC INT function is activated, the GPOUT pin generates 1-ms pulse width under various conditions as described in [Table](#page-9-1) 2-1.

<span id="page-9-1"></span>

	<b>Enable Condition</b>	<b>Pulse Width</b>	<b>Description</b>
Change in SOC.	(SOCI Delta) $\neq 0$	1 ms	During charge, when the SOC is greater than (>) the points, $100\% - n \times$ (SOCI Delta) and 100%; During discharge, when the SOC reaches $(\le)$ the points 100% – n $\times$ (SOCI Delta) and 0%; where n is an integer starting from 0 to the number generating SOC no less than $0\%$ Examples: For <b>SOCI Delta</b> = 1% (default), the SOC INT intervals are 0%, 1%, 2%, 99%, and 100%. For <b>SOCI Delta</b> = 10%, the SOC INT intervals are 0%, 10%, 20%,  90%, and 100%.
State Change	(SOCI Delta) $\neq 0$	ms	Upon detection of entry to a charge or a discharge state. Relaxation is not included.
Battery Removal	[BIE] bit is set in OpConfig	1 ms	When battery removal is detected by BIN pin.

**Table 2-1. SOC\_INT Function Definition**

#### *2.5.2 Battery Detection (BIN)*

The function of *OpConfig[BIE]* bit is described in the [Table](#page-9-2) 2-2 table below. When battery insertion is detected and the INITIALIZATION mode is completed, the bq27441-G1 transitions to NORMAL mode to start Impedance Track fuel gauging. When battery insertion is not detected, the bq27441-G1 remains in INITIALIZATION mode.

#### **Table 2-2. Battery Detection**

<span id="page-9-2"></span>



## *Application Examples*

#### <span id="page-10-0"></span>**3.1 Data Memory Parameter Update Example**

This following example shows the command sequence needed to modify a Data Memory parameter. For this example, the default *Design Capacity* is updated from 1000 mAh to 1200 mAh. All device writes (wr) and reads (rd) are implied to I2C 8-bit addresses 0xAA and 0xAB, respectively.



<span id="page-11-0"></span>

## *Standard Commands*

The bq27441-G1 uses a series of 2-byte standard commands to enable system reading and writing of battery information. Each standard command has an associated command-code pair, as indicated in [Table](#page-11-1) 4-1. Because each command consists of two bytes of data, two consecutive I2C transmissions must be executed both to initiate the command function, and to read or write the corresponding two bytes of data.

<span id="page-11-1"></span>

#### **Table 4-1. Standard Commands**



#### **4.1 Control( ): 0x00/0x01**

Issuing a *Control( )* command requires a subsequent 2-byte subcommand. These additional bytes specify the particular control function desired. The *Control( )* command allows the system to control specific features of the bq27441-G1 during normal operation and additional features when the device is in different access modes, as described in [Table](#page-12-0) 4-2.

<span id="page-12-0"></span>

<b>CNTL FUNCTION</b>	<b>SEALED ACCESS</b> <b>CNTL DATA</b>		<b>DESCRIPTION</b>					
<b>CONTROL STATUS</b>	0x0000	Yes	Reports the status of device.					
DEVICE TYPE	0x0001	Yes	Reports the device type (0x0421).					
FW VERSION	0x0002	Yes	Reports the firmware version of the device.					
DM CODE	0x0004	Yes	Reports the Data Memory Code number stored in NVM.					
PREV MACWRITE	0x0007	Yes	Returns previous MAC command code.					
CHEM ID	0x0008	Yes	Reports the chemical identifier of the Impedance Track™ configuration					
<b>BAT INSERT</b>	0x000c	Yes	Forces the <i>[BAT_DET]</i> bit set when the <i>[BIE]</i> bit is 0.					
<b>BAT REMOVE</b>	0x000d	Yes	Forces the <i>[BAT DET]</i> bit clear when the <i>[BIE]</i> bit is 0.					
<b>SET HIBERNATE</b>	0x0011	Yes	Forces CONTROL_STATUS [HIBERNATE] to 1.					
<b>CLEAR HIBERNATE</b>	0x0012	Yes	Forces CONTROL STATUS [HIBERNATE] to 0.					
<b>SET CFGUPDATE</b>	0x0013	No	Force CONTROL_STATUS [CFGUPMODE] to 1 and gauge enters CONFIG UPDATE mode.					
SHUTDOWN_ENABLE	0x001b	<b>No</b>	Enables device SHUTDOWN mode.					
<b>SHUTDOWN</b>	0x001c	No.	Commands the device to enter SHUTDOWN mode.					
<b>SEALED</b>	0x0020	No.	Places the device in SEALED access mode.					
TOGGLE_GPOUT	0x0023	Yes	Commands the device to toggle the GPOUT pin for 1ms.					
<b>RESET</b>	0x0041	No	Performs a full device reset.					
SOFT_RESET	0x0042	No	Gauge exits CONFIG UPDATE mode.					

**Table 4-2.** *Control( )* **Subcommands**



#### <span id="page-13-0"></span>*4.1.1 CONTROL\_STATUS: 0x0000*

Instructs the fuel gauge to return status information to control addresses 0x00/0x01. The read-only status word contains status bits that are set or cleared either automatically as conditions warrant or through using specified subcommands.



#### **Table 4-3. CONTROL\_STATUS Bit Definitions**

WDRESET = Indicates the bq27441-G1 has performed a Watchdog Reset. Active when set.

SS = Indicates the bq27441-G1 is in the SEALED State. Active when set.

CALMODE = Indicates the bq27441-G1 is in calibration mode. Active when set.

CCA = Indicates the bq27441-G1 Coulomb Counter Auto-Calibration routine is active. The CCA routine will take place approximately 3 minutes and 45 seconds after the initialization as well as periodically as conditions permit. Active when set.

BCA = Indicates the bq27441-G1 board calibration routine is active. Active when set.

QMAX\_UP = Indicates Qmax has Updated. True when set. This bit is cleared after power on reset or when [BAT\_DET] bit is set. When this bit is cleared, it enables fast learning of battery Qmax.

- RES\_UP = Indicates that resistance has been updated. True when set. This bit is cleared after power on reset or when [BAT\_DET] bit is set. Also this bit can only be set after Qmax is updated. ([QMAX\_UP] set). When this bit is cleared, it enables fast learning of battery impedance.
- HIBERNATE Indicates a request for entry into HIBERNATE from SLEEP mode has been issued. True when set.
	- SLEEP = Indicates the bq27441-G1 is in SLEEP mode. True when set.
	- LDMD = Indicates the algorithm is using constant-power mode. True when set. Default is 1.
- RUP\_DIS = Indicates the bq27441-G1 Ra table updates are disabled. Updates are disabled when set.
	- VOK = Indicates cell voltages are OK for Qmax updates. True when set.

RSVD = Reserved.

### <span id="page-13-1"></span>*4.1.2 DEVICE\_TYPE: 0x0001*

=

Instructs the fuel gauge to return the device type to addresses 0x00/0x01. The value returned is 0x0421. (Note: Value returned is 0x0421 even if the product is bq27441-G1 so the distinguishing identification requires both DEVICE\_TYPE and DM\_CODE)

#### <span id="page-13-2"></span>*4.1.3 FW\_VERSION: 0x0002*

Instructs the fuel gauge to return the firmware version to addresses 0x00/0x01.

#### <span id="page-13-3"></span>*4.1.4 DM\_CODE: 0x0004*

Instructs the fuel gauge to return the 8-bit *DM Code* as the least significant byte of the 16-bit return value at addresses 0x00 and 0x01. The DM\_CODE subcommand provides a simple method to determine the configuration code stored in Data Memory.



#### <span id="page-14-0"></span>*4.1.5 PREV\_MACWRITE: 0x0007*

Instructs the fuel gauge to return the previous command written to addresses 0x00/0x01. The value returned is limited to less than 0x0015.

#### <span id="page-14-1"></span>*4.1.6 CHEM\_ID: 0x0008*

Instructs the fuel gauge to return the chemical identifier for the Impedance Track configuration to addresses 0x00/0x01. The expected value for bq27441-G1A is 0x0128 and for bq27441-G1B is 0x0312.

#### <span id="page-14-2"></span>*4.1.7 BAT\_INSERT: 0X000C*

This subcommand forces the *Flags() [BAT\_DET]* bit to set when the battery insertion detection is disabled via *OpConfig[BIE=0]*. In this case, the gauge does not detect battery insertion from the BIN pin's logic state, but relies on the BAT\_INSERT host subcommand to indicate battery presence in the system. This subcommand also starts Impedance Track gauging.

#### <span id="page-14-3"></span>*4.1.8 BAT\_REMOVE: 0X000D*

This subcommand forces the *Flags() [BAT\_DET]* bit to clear when the battery insertion detection is disabled via *OpConfig[BIE=0]*. In this case, the gauge does not detect battery removal from the BIN pin's logic state, but relies on the BAT\_REMOVE host subcommand to indicate battery removal from the system.

#### <span id="page-14-4"></span>*4.1.9 SET\_HIBERNATE: 0x0011*

Instructs the fuel gauge to force the CONTROL\_STATUS*[HIBERNATE]* bit to 1. If the necessary conditions are met, this enables the gauge to enter the HIBERNATE power mode after the transition to SLEEP power state is detected. The *[HIBERNATE]* bit is automatically cleared upon exiting from HIBERNATE mode.

#### <span id="page-14-5"></span>*4.1.10 CLEAR\_HIBERNATE: 0x0012*

Instructs the fuel gauge to force the CONTROL\_STATUS*[HIBERNATE]* bit to 0. This prevents the gauge from entering the HIBERNATE power mode after the transition to SLEEP power state is detected. It can also be used to force the gauge out of HIBERNATE mode.

#### *4.1.11 SET\_CFGUPDATE: 0x0013*

Instructs the fuel gauge to set the *Flags[CFGUPMODE]* bit to 1 and enter CONFIG UPDATE mode. This command is only available when the fuel gauge is UNSEALED. Note: A SOFT\_RESET subcommand is typically used to exit CONFIG UPDATE mode to resume normal gauging.

#### <span id="page-14-6"></span>*4.1.12 SHUTDOWN\_ENABLE: 0x001B*

Instructs the fuel gauge to enable SHUTDOWN mode and set the CONTROL\_STATUS*[SHUTDOWNEN]* status bit.

#### <span id="page-14-7"></span>*4.1.13 SHUTDOWN: 0x001C*

Instructs the fuel gauge to immediately enter SHUTDOWN mode after receiving this subcommand. The SHUTDOWN mode effectively a power down mode with only a small circuit biased by the BAT pin used to wake up detection. To enter SHUTDOWN mode, the SHUTDOWN\_ENABLE command must have been previously received. The fuel gauge wakes up from SHUTDOWN mode upon detection of a low-to-high transition on the open-drain GPOUT pin.



#### <span id="page-15-0"></span>*4.1.14 SEALED: 0x0020*

Instructs the fuel gauge to transition from UNSEALED state to SEALED state. The fuel gauge should always be set to SEALED state for use in end equipment.

#### <span id="page-15-1"></span>*4.1.15 PULSE\_SOC\_INT: 0x0023*

This subcommand can be useful for system level debug or test purposes. It instructs the fuel gauge to pulse the GPOUT pin for approximately 1 ms within 1 second of receiving the command. Note: The GPOUT pin must be configured for the SOC\_INT output function with *OpConfig[BATLOWEN]* cleared.

#### <span id="page-15-2"></span>*4.1.16 RESET : 0x0041*

This command instructs the fuel gauge to perform a full device reset and reinitialize RAM data to the default values from ROM and is therefore not typically used in field operation. The gauge sets the *Flags[ITPOR]* bit and enters the INITIALIZE mode. Refer to [Figure](#page-8-0) 2-1. This command is only available when the fuel gauge is UNSEALED.

#### *4.1.17 SOFT\_RESET : 0x0042*

This command instructs the fuel gauge to perform a partial (soft) reset from any mode with an OCV measurement. The *Flags[ITPOR, CFGUPMODE]* bits are cleared and a resimulation occurs to update *StateOfCharge( )*. Refer to [Figure](#page-8-0) 2-1. This command is only available when the fuel gauge is UNSEALED.



#### <span id="page-16-0"></span>**4.2 Temperature( ): 0x02/0x03**

This read-/write-word function returns an unsigned integer value of the temperature in units of 0.1 K measured by the fuel gauge. If *OpConfig[TEMPS]* bit = 0 (default), a read command will return the internal temperature sensor value and write command will be ignored. If *OpConfig[TEMPS]* bit = 1, a write command sets the temperature to be used for gauging calculations while a read command returns to temperature previously written.

#### <span id="page-16-1"></span>**4.3 Voltage( ): 0x04/0x05**

This read-only function returns an unsigned integer value of the measured cell-pack voltage in mV with a range of 0 to 6000 mV.

#### <span id="page-16-2"></span>**4.4 Flags( ): 0x06/0x07**

This read-word function returns the contents of the fuel gauging status register, depicting the current operating status.



#### **Table 4-4. Flags Bit Definitions**

- OT = Over-Temperature condition is detected. *[OT]* is set when *Temperature( )* ≥ *Over Temp* (default = 55 °C). *[OT]* is cleared when *Temperature( )* < *Over Temp* - *Temp Hys*.
- UT = Under-Temperature condition is detected. *[UT]* is set when *Temperature( )* ≤ *Under Temp* (default = 0 °C). *[UT]* is cleared when *Temperature( )* > *Under Temp* + *Temp Hys*.
- RSVD = Reserved. (High Byte bits 5:2)
	- FC = Full-charge is detected. If the *FC Set%* (default =100%) is a positive threshold , *[FC]* is set when SOC ≥ *FC Set* % and is cleared when SOC ≤ *FC Clear* % (default = 98%). Alternatively, if *FC Set%* = -1, *[FC]* is set when the fuel gauge has detected charge termination.
- CHG = Fast charging allowed. If the *TCA Set%* (Terminate Charge Alarm Set %) is a positive threshold (default = 99%), *[CHG]* is cleared when SOC ≥ *TCA Set %* and is set when SOC ≤ *TCA Clear %* (default = 95%). Alternatively, if *TCA Set%* = -1, the TCA thresholds are disabled and the *[CHG]* bit is cleared when the fuel gauge has detected a taper condition.
- OCVTAKEN = Cleared on entry to relax mode and Set to 1 when OCV measurement is performed in relax
	- RSVD = Reserved.
	- ITPOR = Indicates a Power On Reset or RESET subcommand has occurred. If set, this bit generally indicates that the RAM configuration registers have been reset to default values and the host should reload the configuration parameters using the CONFIG UPDATE mode. This bit is cleared after the SOFT\_RESET subcommand is received.
- CFGUPMODE Fuel gauge is in CONFIG UPDATE mode. True when set. Default is 0. Refer to CONFIG UPDATE Mode section = for details.
	- BAT\_DET = Battery insertion detected. True when set. When *OpConfig[BIE]]* is set, *[BAT\_DET]* is set by detecting a logic high to low transition at BIN pin. when *OpConfig[BIE]]* is low, *[BAT\_DET]* is set when host issues BAT\_INSERT subcommand and clear when host issues BAT\_REMOVE subcommand.
		- SOC1 = If set, *StateOfCharge()* <= *SOC1 Set Threshold*. The [SOC1] bit will remain set until *StateOfCharge()* >= *SOC1 Clear Threshold*.
		- SOCF = If set, *StateOfCharge()* <= *SOCF Set Threshold*. The [SOCF] bit will remain set until *StateOfCharge()* >= *SOCF Clear Threshold*.
		- DSG = Discharging detected. True when set.

#### <span id="page-17-0"></span>**4.5 NominalAvailableCapacity( ): 0x08/0x09**

This read-only command pair returns the uncompensated (less than C/20 load) battery capacity remaining. Units are mAh.

#### <span id="page-17-1"></span>**4.6 FullAvailableCapacity( ): 0x0a/0x0b**

This read-only command pair returns the uncompensated (less than C/20 load) capacity of the battery when fully charged. Units are mAh. *FullAvailableCapacity( )* is updated at regular intervals, as specified by the IT algorithm.

### <span id="page-17-2"></span>**4.7 RemainingCapacity( ): 0x0c/0x0d**

This read-only command pair returns the compensated battery capacity remaining. Units are mAh.

#### <span id="page-17-3"></span>**4.8 FullChargeCapacity( ): 0x0e/0f**

This read-only command pair returns the compensated capacity of the battery when fully charged. Units are mAh. *FullChargeCapacity( )* is updated at regular intervals, as specified by the IT algorithm.

#### <span id="page-17-4"></span>**4.9 AverageCurrent( ): 0x10/0x11**

This read-only command pair returns a signed integer value that is the average current flow through the sense resistor. In NORMAL mode, it is updated once per second and is calculated by dividing the 1 second change in coulomb counter data by 1 second. Large current spikes of short duration will be averaged out in this measurement. Units are mA.

#### <span id="page-17-5"></span>**4.10 StandbyCurrent( ): 0x12/0x13**

This read-only function returns a signed integer value of the measured standby current through the sense resistor. The *StandbyCurrent( )* is an adaptive measurement. Initially it reports the standby current programmed in *Initial Standby*, and after spending several seconds in standby, reports the measured standby current.

The register value is updated every second when the measured current is above the *Deadband* and is less than or equal to 2 × *Initial Standby*. The first and last values that meet this criteria are not averaged in, because they may not be stable values. To approximate a 1-minute time constant, each new *StandbyCurrent( )* value is computed by taking approximately 93% weight of the last standby current and approximately 7% of the current measured average current.

#### **4.11 MaxLoadCurrent( ): 0x14/0x15**

This read-only function returns a signed integer value, in units of mA, of the maximum load conditions. The *MaxLoadCurrent( )* is an adaptive measurement which is initially reported as the maximum load current programmed in *Initial MaxLoad* current. If the measured current is ever greater than *Initial MaxLoad*, then *MaxLoadCurrent( )* updates to the new current. *MaxLoadCurrent( )* is reduced to the average of the previous value and *Initial MaxLoad* whenever the battery is charged to full after a previous discharge to an SOC less than 50%. This prevents the reported value from maintaining an unusually high value.



#### <span id="page-18-0"></span>**4.12 AveragePower( ): 0x18/0x19**

This read-only function returns an signed integer value of the average power during battery charging and discharging. It is negative during discharge and positive during charge. A value of 0 indicates that the battery is not being discharged. The value is reported in units of mW.

#### <span id="page-18-1"></span>**4.13 StateOfCharge( ): 0x1c/0x1d**

This read-only function returns an unsigned integer value of the predicted remaining battery capacity expressed as a percentage of *FullChargeCapacity( )*, with a range of 0 to 100%.

#### <span id="page-18-2"></span>**4.14 IntTemperature( ): 0x1e/0x1f**

This read-only function returns an unsigned integer value of the internal temperature sensor in units of 0.1 K measured by the fuel gauge. If *OpConfig[TEMPS]* = 0, this command will return the same value as *Temperature( )*.

#### <span id="page-18-3"></span>**4.15 StateOfHealth( ): 0x20/0x21**

0x20 SOH percentage: this read-only function returns an unsigned integer value, expressed as a percentage of the ratio of predicted FCC(25°C, *SOH LoadI*) over the *DesignCapacity()*. The FCC(25°C, *SOH LoadI*) is the calculated full charge capacity at 25°C and the *SOH LoadI* which is programmed in factory (default = –400mA). The range of the returned SOH percentage is 0x00 to 0x64, indicating 0 to 100% correspondingly.

0x21 SOH Status: this read-only function returns an unsigned integer value, indicating the status of the SOH percentage:

- 0x00: SOH not valid (initialization)
- 0x01: Instant SOH value ready
- 0x02: Initial SOH value ready
	- Calculation based on default Qmax
	- May not reflect SOH for currently inserted pack
- 0x03: SOH value ready
	- Calculation based on learned Qmax
	- Most accurate SOH for currently inserted pack following a Qmax update
- 0x04-0xFF: Reserved

<span id="page-19-0"></span>

## *Extended Data Commands*

Extended data commands offer additional functionality beyond the standard set of commands. They are used in the same manner; however unlike standard commands, extended commands are not limited to 2 byte words. The number of command bytes for a given extended command ranges in size from single to multiple bytes, as specified in [Table](#page-19-5) 5-1.

<span id="page-19-5"></span>

#### **Table 5-1. Extended Commands**

(1) SEALED and UNSEALED states are entered via commands to *Control( )* 0x00/0x01

 $(2)$  In sealed mode, data CANNOT be accessed through commands 0x3e and 0x3f.

### <span id="page-19-1"></span>**5.1 OpConfig( ): 0x3a/0x3b**

SEALED and UNSEALED Access: This command returns the *OpConfig* Data Memory register setting which is most useful for system level debug to quickly determine device configuration.

#### <span id="page-19-2"></span>**5.2 DesignCapacity( ): 0x3c/0x3d**

SEALED and UNSEALED Access: This command returns the *Design Capacity* Data Memory value and is most useful for system level debug to quickly determine device configuration.

#### <span id="page-19-3"></span>**5.3 DataClass( ): 0x3e**

UNSEALED Access: This command sets the data class to be accessed. The class to be accessed should be entered in hexadecimal.

SEALED Access: This command is not available in SEALED mode.

#### <span id="page-19-4"></span>**5.4 DataBlock( ): 0x3f**

UNSEALED Access: This command sets the data block to be accessed. When 0x00 is written to *BlockDataControl( )*, *DataBlock( )* holds the block number of the data to be read or written. Example: writing a 0x00 to *DataBlock( )* specifies access to the first 32 byte block and a 0x01 specifies access to the second 32 byte block, and so on.

SEALED Access: Issuing a 0x01 instructs the *BlockData( )* command to transfer the *Manufacturer Info* block.



### <span id="page-20-0"></span>**5.5 BlockData( ): 0x40…0x5f**

UNSEALED Access: This data block is the remainder of the 32 byte data block when accessing general block data.

#### <span id="page-20-1"></span>**5.6 BlockDataChecksum( ): 0x60**

UNSEALED Access: This byte contains the checksum on the 32 bytes of block data read or written. The least-significant byte of the sum of the data bytes written must be complemented ( [255 – *x*] , for *x* the least-significant byte) before being written to 0x60. For a block write, the correct complemented checksum must be written before the *BlockData( )* will be transferred to RAM.

SEALED Access: This byte contains the checksum for the 8 bytes of the *Manufacturer Info* block.

#### <span id="page-20-2"></span>**5.7 BlockDataControl( ): 0x61**

UNSEALED Access: This command is used to control the data access mode. Writing 0x00 to this command enables *BlockData( )* to access to RAM.

SEALED Access: This command is not available in SEALED mode.

#### <span id="page-20-3"></span>**5.8 Reserved – 0x62 – 0x7f**

<span id="page-21-0"></span>

## *Data Memory*

#### <span id="page-21-1"></span>**6.1 Data Memory Interface**

#### <span id="page-21-2"></span>*6.1.1 Accessing the Data Memory*

The fuel gauge's Data Memory contains initialization, default, cell status, calibration, configuration, and user information. Most Data Memory parameters reside in volatile RAM that are initialized by associated parameters from ROM. However, some Data Memory parameters are directly accessed from ROM and do not have an associated RAM copy. The Data Memory can be accessed in several different ways, depending on what mode the fuel gauge is operating in and what data is being accessed.

Commonly accessed Data Memory locations, frequently read by a system, are conveniently accessed through specific instructions, already described in [Chapter](#page-19-0) 5, *Extended Data Commands*. These commands are available when the fuel gauge is either in UNSEALED or SEALED modes.

Most Data Memory locations, however, are only accessible in UNSEALED mode by use of the evaluation software or by Data Memory block transfers. These locations should be optimized and/or fixed during the development and manufacturing processes. They become part of a golden image file and then can be written to multiple battery packs. Once established, the values generally remain unchanged during endequipment operation.

To access Data Memory locations individually, the block containing the desired Data Memory location(s) must be transferred to the command register locations, where they can be read to the system or changed directly. This is accomplished by sending the set-up command *BlockDataControl( )* (0x61) with data 0x00. Up to 32 bytes of data can be read directly from the *BlockData( )* (0x40 through 0x5F), externally altered, then rewritten to the *BlockData( )* command space. Alternatively, specific locations can be read, altered, and rewritten if their corresponding offsets index into the *BlockData( )* command space. Finally, the data residing in the command space is transferred to Data Memory, once the correct checksum for the whole block is written to *BlockDataChecksum( )* (0x60).

Occasionally, a Data Memory class is larger than the 32-byte block size. In this case, the *DataBlock( )* command designates in which 32-byte block the desired locations reside. The correct command address is then given by 0x40 + offset modulo 32. For an example of this type of Data Memory access, refer to [Section](#page-10-0) 3.1.

Reading and writing subclass data are block operations up to 32 bytes in length. During a write, if the data length exceeds the maximum block size, then the data is ignored.

None of the data written to memory are bounded by the fuel gauge — the values are not rejected by the fuel gauge. Writing an incorrect value may result in hardware failure due to firmware program interpretation of the invalid data. The written data is persistent, so a power-on reset does resolve the fault.



#### <span id="page-22-0"></span>*6.1.2 Access Modes*

The fuel gauge provides two access modes, UNSEALED and SEALED, that control the Data Memory access permissions. The default access mode of the bq27441-G1 is UNSEALED, so the system processor must send a SEALED subcommand after a gauge reset in order to utilize the data protection feature.

#### <span id="page-22-1"></span>*6.1.3 SEALING and UNSEALING Data Memory Access*

The fuel gauge implements a key-access scheme to transition from SEALED to UNSEALED mode. Once SEALED via the associated subcommand, a unique set of two keys must be sent to the fuel gauge via the *Control( )* command to return to UNSEALED mode. The keys must be sent consecutively, with no other data being written to the *Control( )* register in between.

When in the SEALED mode, the CONTROL\_STATUS [SS] bit is set; but when the *Sealed to Unsealed* keys are correctly received by the fuel gauge, the [SS] bit is cleared. The *Sealed to Unsealed* key has two identical words stored in ROM with a value of 0x80008000. Then *Control( )* should supply 0x8000 and 0x8000 (again) to unseal the part.

#### <span id="page-22-2"></span>**6.2 Data Types Summary**



#### **Table 6-1. Data Type Decoder**

### <span id="page-23-0"></span>**6.3 Data Memory Summary Tables**



### **Table 6-2. Data Memory Summary - Configuration**







<b>Subclass</b> ID	<b>Subclass</b>	Offset	Name	Data <b>Type</b>	Min Value	Max Value	$(-G1A/B)$ <b>Default</b>	<b>Units</b> (EVSW Units)*
81	<b>Current Thresholds</b>	0	Dsg Current Threshold	12	0	2000	167	mA
		$\overline{2}$	Chg Current Threshold	12	$\mathbf 0$	2000	100	mA
		$\overline{4}$	<b>Quit Current</b>	12	$\mathbf 0$	1000	250	mA
		6	Dsg Relax Time	U <sub>2</sub>	$\mathsf 0$	8191	60	$\mathbf s$
		8	Chg Relax Time	U1	$\mathsf 0$	255	60	$\mathbf s$
		9	Quit Relax Time	U1	$\mathbf 0$	63	$\mathbf{1}$	${\tt S}$
		10	<b>Transient Factor Charge</b>	U1	$\mathbf 0$	255	179	
		11	<b>Transient Factor Discharge</b>	U1	$\mathbf 0$	255	179	
		12	Max IR Correct	U <sub>2</sub>	0	1000	400	mV
82	State	$\mathbf 0$	Qmax Cell 0	12	$\mathbf 0$	32767	16384	mAh
		$\overline{2}$	<b>Update Status</b>	H1	0x00	0x36	0x00	
		3	Reserve Cap-mAh	12	$\mathbf 0$	9000	$\mathbf 0$	mA
		5	Load Select/Mode	H1	0x00	0xFF	0x81	
		6	Q Invalid Max V	12	0	32767	$A = 3803$ $B = 3814$	mV
		8	Q Invalid Min V	12	$\mathbf 0$	32767	$A = 3752$ $B = 3748$	mV
		10	Design Capacity	12	$\mathbf 0$	32767	$A = 1340$ $B = 1000$	mA
		12	Design Energy	12	$\mathbf 0$	32767	$A = 4960$ $B = 3700$	mWh
		14	Default Design Cap	12	$\mathbf 0$	32767	$A = 1340$ $B = 5580$	mWh
		16	<b>Terminate Voltage</b>	12	2800	3700	3200	mV
		26	SOCI Delta	U1	$\mathbf 0$	100	$\mathbf{1}$	%
		27	<b>Taper Rate</b>	12	$\mathbf 0$	2000	100	.1 Hr rate
		29	<b>Taper Voltage</b>	12	$\mathbf 0$	5000	$A = 4100$ $B = 4200$	mV
		31	Sleep Current	12	$\mathbf 0$	100	10	mA
		33	V at Chg Term	12	$\mathbf 0$	5000	$A = 4190$ $B = 4290$	mV
		35	Avg I Last Run	12	$-32768$	32767	$-50$	mA
		37	Avg P Last Run	12	$-32768$	32767	$-50$	mW
		39	Delta Voltage	12	$-32768$	32767	$\mathbf{1}$	mV

**Table 6-3. Data Memory Summary - Gas (Fuel) Gauging (continued)**



#### *Data Memory Summary Tables* [www.ti.com](http://www.ti.com)



#### **Table 6-4. Data Memory Summary - Resistance Tables**

### **Table 6-5. Data Memory Summary - Calibration and Security**





#### **6.4 Data Memory Parameter Descriptions**

#### <span id="page-26-0"></span>*6.4.1 Configuration Class*

#### **6.4.1.1 Safety Subclass 2**

#### *6.4.1.1.1 Over Temp, Under Temp, Temp Hys*



An Over-Temperature condition is detected if *Temperature( )* ≥ *Over Temp* (default = 55 °C) and indicated by setting the *Flags( )* [OT] bit. The *[OT]* bit is cleared when *Temperature( )* < *Over Temp* - *Temp Hys* (default =  $50^{\circ}$ C).

An Under-Temperature condition is detected if *Temperature( )* ≤ *Under Temp* (default = 0 °C) and indicated by setting the *Flags( )* [UT] bit. The *[UT]* bit is cleared when *Temperature( )* > *Under Temp* + **Temp Hys** (default =  $5^{\circ}$ C).

#### **6.4.1.2 Charge Termination Subclass 36**

#### *6.4.1.2.1 Min Taper Capacity, Current Taper Window*



Refer to description of *Taper Rate* and *Taper Voltage* for details on *Min Taper Capacity* and *Current Taper Window*. See Section [6.4.2.3.9](#page-39-0).

#### *6.4.1.2.2 Terminate Charge Alarm Set % (TCA Set %), Terminate Charge Alarm Clear % (TCA Clear %)*



The *Flags( )* [CHG] bit is set when SOC reaches *TCA Set* and is cleared when it drops below *TCA Clear*. The *Flags( )* [CHG] bit is set when Primary Charge Termination conditions are met and *TCA Set* is set to –1%.

#### *6.4.1.2.3 Full Charge Set % (FC Set %), Full Charge Clear % (FC Clear %)*



The *Flags( )* [FC] bit is set when SOC reaches *FC Set* and is cleared when it drops below *FC Clear*.

The *Flags( )* [FC] bit is set when Primary Charge Termination conditions are met and *FC Set* is set to  $-1\%$ .

#### *6.4.1.2.4 DOD at EOC Delta Temperature*



During relaxation and charge start, **REMCAP** = *FullChargeCapacity( )* – *Qstart( )*. But with temperature decreases, *Qstart( )* can become much smaller than old *FullChargeCapacity( )* resulting in over-estimation of **REMCAP**. To improve accuracy, *FullChargeCapacity( )* is updated when temperature change from previous *FullChargeCapacity( )* update is more than *DODatEOC Delta T*.

#### **6.4.1.3 Data Subclass 48**

#### *6.4.1.3.1 Initial Standby Current*



This is the initial value that is reported in *StandbyCurrent( )*. The *StandbyCurrent( )* value is updated every 1 second when the measured current meets the following criteria: |Current| > *Deadband* and Current ≤ 2 × *Initial Standby.*

#### *Note: Current is negative during discharge.*

This value depends on the system. The initial standby current is the current load drawn by the system when in low-power mode.

#### *6.4.1.3.2 Initial Maximum Load Current*



This is the initial value that is reported in *MaxLoadCurrent( )*. The *MaxLoadCurrent( )* is updated to the new current when Current > *Initial MaxLoad*. *MaxLoadCurrent( )* is reduced to the average of the previous value and *Initial MaxLoad* whenever the battery is charged to full after a previous discharge to an SOC less than 50%. This prevents the reported value from maintaining an unusually high value. Default value depends on the system.

#### **6.4.1.4 Discharge Subclass 49**

#### *6.4.1.4.1 State of Charge 1 Set or Clear Threshold (SOC1 Set Threshold, SOC1 Clear Threshold)*



When *RemainingCapacity( )* falls to or below the first capacity threshold, specified in *SOC1 Set Threshold*, the *Flags( )* [SOC1] bit is set. This bit is cleared once *RemainingCapacity( )* rises to or above *SOC1 Clear Threshold*.

These values are user preference.

#### *6.4.1.4.2 State of Charge Final Set or Clear Threshold (SOCF Set Threshold, SOCF Clear Threshold)*



When *RemainingCapacity( )* falls to or below the final capacity threshold, specified in *SOCF Set Threshold*, the *Flags( )* [SOCF] bit is set. This bit is cleared once *RemainingCapacity( )* rises to or above *SOCF Clear Threshold*. The [SOCF] bit serves as the final discharge warning.

These values are user preference.

*Data Memory Parameter Descriptions* [www.ti.com](http://www.ti.com)

#### **6.4.1.5 Registers Subclass 64**

#### *6.4.1.5.1 OpConfig*



#### **Table 6-6. Op Config Register Definition**



- BIE = Battery Insertion Enable. If set, the battery insertion is detection via BIN pin input. If cleared, the detection relies on the host to issue BAT\_INSERT subcommand to indicate battery presence in the system.
- BI\_PU\_EN = Enables internal weak pull-up on BIN pin. True when set. If false, an external pull-up resistor is expected.
- GPIOPOL = GPOUT pin is active-high if set or active-low if cleared.
	- SLEEP = The fuel gauge can enter sleep, if operating conditions allow. True when set.
	- RMFCC = RM is updated with the value from FCC on valid charge termination. True when set.
- BATLOWEN = If set, the BAT\_LOW function for GPOUT pin is selected. If cleared, the SOC\_INT function is selected for GPOUT.
	- TEMPS = Selects the temperature source. Enables the host to write *Temperature( )* if set. If cleared, the internal temperature sensor is used for *Temperature( )*.
	- RSVD0 = Reserved. Default is 0. (Set to 0 for proper operation)
	- RSVD1 = Reserved. Default is 1. (Set to 1 for proper operation)

#### *6.4.1.5.2 OpConfigB*







SMOOTHEN = Enables the SOC smoothing feature. True when set.

RSVD0 = Reserved. Default is 0. (Set to 0 for proper operation)

RSVD1 = Reserved. Default is 1. (Set to 1 for proper operation)

#### *6.4.1.5.3 DM Code*



This register contains the value to be returned by the DM\_CODE subcommand. In addition to the CHEMID subcommand, the DM\_CODE subcommand can be used to distinguish bq27441-G1 A and bq27441-G1B device.

#### **6.4.1.6 Power Subclass 68**

#### *6.4.1.6.1 Hibernate Current*



When |*AverageCurrent( )*| < *Hibernate I*, the gauge enters HIBERNATE mode if CONTROL\_STATUS [HIBERNATE] bit is set and cell is relaxed. This setting should be below any normal application currents.

#### *6.4.1.6.2 Hibernate Voltage*



When |Voltage| < *Hibernate V*, the gauge enters HIBERNATE mode. The CONTROL\_STATUS [HIBERNATE] bit has no impact for the gauge to enter HIBERNATE mode. This setting should be below any normal application voltage.

#### *6.4.1.6.3 Full Sleep Wait Time*



FULLSLEEP mode can be entered by setting the *FS Wait* to a number larger than 0. The FULLSLEEP mode is entered when the timer counts down to 0.

This value is set to 0 to disable the *FS Wait* function.

#### <span id="page-31-0"></span>*6.4.2 Gas (Fuel) Gauging Class*

#### **6.4.2.1 IT Cfg Subclass 80**

#### *6.4.2.1.1 Sample Secondary Relax Time*



*Sec. Relax Time* sets the measurement frequency of the Ra values that calculate the Ra grid point value. At the same time, it also sets the frequency of Fast Ra Scaling calculation.

#### *6.4.2.1.2 Average Time (Sample Average Relax Time)*



Sample *Average Time* specifies time used for voltage, temperature, and current averages used for resistance calculation.

#### *6.4.2.1.3 Minimum DOD Resistance Update*



*Min DOD Res Update* specifies the delta DOD between 2 grid points. Resistance measurements are not used for the next grid calculation if they were made below *Min DOD Res Update*.

#### *6.4.2.1.4 Maximum and Minimum Resistance Factors*



The *Max Res Factor* and *Min Res Factor* parameters are cumulative filters which limit the change in Ra values to a scale on a per discharge cycle basis.

For Ra\_new > Ra\_old, New  $Ra = min(Ra_new, Ra_old \times Max Res Factor \div 10)$ 

For Ra\_new < Ra\_old New Ra = max(Ra\_new, Ra\_old × *Min Res Factor* ÷ 10)

#### *6.4.2.1.5 Ra Filter*



*Ra Filter* is a filter constant used to calculate the filtered Ra value that is stored into Data Memory from the old Ra value.

Ra = (Ra\_old × *Ra Filter* + Ra\_new × (1000 – *Ra Filter*) ) ÷ 1000

#### *6.4.2.1.6 Max V Delta*



*Max V Delta* specifies dV/dt condition for Qmax qualification in Relax mode. Value of 10 corresponds to 1 µV/s.

#### *6.4.2.1.7 Fast Qmax Start DOD%, Fast Qmax Start Voltage Delta, Fast Qmax Current Threshold*



Fast Qmax measurement starts when the following conditions are met,

- DOD > *Fast Qmax Start DOD%* or Voltage < *Terminate Voltage* + *Fast Qmax Start Volt Delta*
- Current < C / *Fast Qmax Current Threshold*

#### *6.4.2.1.8 Fast Qmax End DOD%, Fast Qmax Minimum Data Points, Fast Qmax Update Voltage Buffer*



Fast Qmax measurement is calculated at the end of discharge when the following conditions are met:

• Number of Fast Qmax measurements > *Fast Qmax Min Points*

• DOD > *Fast Qmax End DOD%* or Voltage < *Terminate Voltage* + *Fast Qmax Volt Buffer*

#### *Data Memory Parameter Descriptions* [www.ti.com](http://www.ti.com)

#### *6.4.2.1.9 Qmax Capacity Error*



*Qmax Capacity Err* specifies maximum capacity error allowed during Qmax update. Capacity error is estimated based on the time spent for Qmax measurement.

#### *6.4.2.1.10 Maximum Qmax Change*



*Max Qmax Change* specifies maximum allowed change in Qmax value during Qmax update. Qmax update is disqualified if change from previous Qmax value is greater than *Max Qmax Change*.

#### *6.4.2.1.11 Simulation Res Relax Time (ResRelax Time)*



This value is used for Impedance Track transient modeling of effective resistance. The resistance increases from zero to final value determined by the Ra table as defined by the exponent with time constant *Res Relax Time* during discharge simulation. Default value has been optimized for typical cell behavior.

#### *6.4.2.1.12 User Rate-Pwr*



This is the discharge rate in mW used for Impedance Track simulation of voltage profile to determine discharge capacity. It is only used when *Load Mode* = 1 (constant-power) and *Load Select* = 6 (userdefined rate).

#### *6.4.2.1.13 Reserve Energy (Reserve Cap-mWh)*



**Reserve Cap-mWh** determines how much actual remaining capacity exists after reaching 0 *RemainingCapacity( )* before *Terminate Voltage* is reached. This register is only used if *Load Mode* = 1 (constant-power). A no-load rate of compensation is applied to this reserve capacity. This is a specialized function to allow time for a controlled shutdown after 0 *RemainingCapacity( )* is reached.

#### *6.4.2.1.14 Max Simulation Rate, Min Simulation Rate*



Maximum and minimum limits for current used in simulation runs. The parameters are functions of *DesignCapacity( )* (that is, C/*Max Sim Rate* or C/*Min Sim Rate*).

#### *6.4.2.1.15 Ra Max Delta*



During the update of Ra values a filtering process is performed to eliminate unexpected fluctuations in the updated Ra values. *Ra Max Delta* limits the change in Ra values to an absolute magnitude per Ra update.

#### **6.4.2.2 Current Thresholds Subclass 81**

#### *6.4.2.2.1 Discharge Detection Threshold*



This register is used as a threshold in the gauge to determine if actual discharge current is flowing out of the battery. This is independent of the *Flags( )* [DSG] bit, which indicates whether the gauge is in discharge mode or charge mode. If the gauge is charging, then the [DSG] bit is 0 and any other time, the [DSG] bit is set to 1. Impedance Track algorithm in the gauge requires more definitive information about whether current is flowing in either the charge or discharge direction. *Dsg Current Threshold* is used for this purpose. This default threshold should be sufficient for most applications. This threshold should be set low enough to be below any normal application load current but high enough to prevent noise or drift from affecting the measurement.

#### *6.4.2.2.2 Charge Detection Threshold*



This register is used as a threshold in the gauge to determine if actual charge current is flowing into the battery. This is independent of the *Flags( )* [DSG] bit, which indicates whether the gauge is in discharge mode or charge mode. If the gauge is charging, then the [DSG] bit is 0 and any other time, the [DSG] bit is set to 1. Impedance Track algorithm in the gauge requires more definitive information about whether current is flowing in either the charge or discharge direction. *Chg Current Threshold* is used for this purpose. This default threshold should be sufficient for most applications. This threshold should be set low enough to be below any normal charge current but high enough to prevent noise or drift from affecting the measurement.

#### *6.4.2.2.3 Quit Current, Discharge Relax Time, Charge Relax Time*



The *Quit Current* is used as part of the Impedance Track algorithm to determine when the fuel gauge enters relaxation mode from a current flowing mode in either the charge direction or the discharge direction. The value of *Quit Current* is set to a default value that should be above the standby current of the system. Either of the following criteria must be met to enter relaxation mode:

- |*AverageCurrent( )*| < |*Quit Current*| for *Dsg Relax Time*
- |*AverageCurrent( )*| > |*Quit Current*| for *Chg Relax Time*

After about 6 minutes in relaxation mode, the fuel gauge attempts to take accurate OCV readings. An additional requirement of  $dV/dt < 2 \mu V/s$  is required for the fuel gauge to perform Qmax updates. These updates are used in the Impedance Track algorithms. It is critical that the battery voltage be relaxed during OCV readings and that the current is not higher than C/20 when attempting to go into relaxation mode.

The *Quit Current* is used as part of the Impedance Track algorithm to determine when the gauge goes into relaxation mode from a current-flowing mode in either the charge direction or the discharge direction. Either of the following criteria must be met to enter relaxation mode:

- *AverageCurrent( )* is greater than (–)*Quit Current* and then goes within (±)*Quit Current* for *Dsg Relax Time*.
- *AverageCurrent( )* is less than *Quit Current* and then goes within (±)*Quit Current* for *Chg Relax Time*.

After 30 minutes in relaxation mode, the gauge starts checking if the dV/dt < 4 µV/s requirement for OCV readings is satisfied. When the battery relaxes sufficiently to satisfy this criteria, the gauge takes an OCV reading for updating Qmax and for accounting for self-discharge. These updates are used in the Impedance Track algorithms.

It is critical that the battery voltage is relaxed during OCV readings to get the most accurate results. This current must not be higher than C/20 when attempting to go into relaxation mode; however, it should not be too low as to prevent going into relaxation mode due to noise. This should always be less than *Chg Current Threshold* or *Dsg Current Threshold*.

#### *6.4.2.2.4 Quit Relax Time*



The *Quit Relax Time* is a delay time to exit relaxation. If current is great than *Chg Current Threshold* or less than *Dsg Current Threshold* and this condition is maintained during *Quit Relax Time*, then exiting relaxation is permitted.

This setting is particular to handheld applications in which low duty cycle dynamic loads are possible.

#### *6.4.2.2.5 Transient Factor Charge, Transient Factor Discharge*



The *Transient Factor Charge* and *Transient Factor Discharge* parameters provide an adjustment of the computed resistance due to transient voltage readings upon pack insertion for either charge or discharge conditions. The values range from 0 to 255 (default 179) and used as a scaling factor / 256 to adjust resistance such that  $R$ \_adj = R  $*$  Transient\_Factor / 256.

#### *6.4.2.2.6 Max IR Correct*



The *Max IR Correct* is a maximum IR correction applied to OCV lookup under load. It only applies to OCV lookup after wakeup with detected charge current when gauge needs to establish capacity baseline, but the current is already flowing.

#### **6.4.2.3 State Subclass 82**

#### *6.4.2.3.1 Qmax Cell 0*



Qmax contains the maximum chemical capacity of the cell, and is determined by comparing states of charge before and after applying the load with the amount of charge passed. It corresponds to capacity at low rate (~C/20) of discharge. For high accuracy, this value is periodically updated by the gauge during operation. The Impedance Track algorithm updates this value and maintains it.

#### *6.4.2.3.2 Update Status*



Bit 0 (0x01) of the *Update Status* register indicates that the gauge has learned new Qmax parameters and is accurate. The remaining bits are reserved. Bit 0 is updated as needed by the Impedance Track algorithm and should never be modified.

#### *6.4.2.3.3 Reserve Capacity (Reserve Cap-mAh)*



*Reserve Cap-mAh* determines how much actual remaining capacity exists after reaching 0 *RemainingCapacity( )* before *Terminate Voltage* is reached. This register is only used if *Load Mode* = 0 (constant-current). A no-load rate of compensation is applied to this reserve capacity. This is a specialized function to allow time for a controlled shutdown after 0 *RemainingCapacity( )* is reached.

#### *6.4.2.3.4 Load Select/Mode*



*Load Mode* configures the fuel gauge to use either a constant-current or constant-power model for the Impedance Track algorithm as. When *Load Mode* is 0, the Constant Current Model is used. When 1 (default), the Constant Power Model is used. The CONTROL\_STATUS [LDMD] bit reflects the status of *Load Mode*.

*Load Select* is used in conjunction with *Load Mode* to define the type of load model that computes the load-compensated capacity in the Impedance Track algorithm.

If *Load Mode* = 0 (Constant current), then the following options are available:





Load Mode = Bit 7 contains the value for *Load Mode*. Refer to tables below for operational details.

RSVD = Reserved. Set to 0 for proper operation.

Load Select[2:0] = Bits 2:0 contain the value for *Load Select*. Refer to tables below for operational details. Default is 1.





If *Load Mode* = 1 (Constant power) then the following options are available:





#### *6.4.2.3.5 Q Invalid Maximum and Minimum Voltage*



*Q Invalid Max V* and *Q Invalid Min V* specify the Qmax disqualification voltage region generally known as the "flat region" of the OCV vs DOD curve. OCV measurement for Qmax calculation is disallowed in this region.

#### *6.4.2.3.6 Design Capacity, Design Energy, Default Design Cap*



*Design Capacity* is used for compensated battery capacity remaining and capacity when fully charged calculations are done by the gauge. It is also used for constant-current model for Impedance Track algorithm when *Load Mode* is 0 (constant-current) and *Load Select* is 4 (*Design Capacity* / 5 for constant discharge). The CONTROL\_STATUS [LDMD] bit indicates Impedance Track algorithm using constant-current model when cleared.

*Design Energy* is used for compensated battery capacity remaining and capacity when fully charged calculations are done by the gauge. It is also used for constant-power model for Impedance Track algorithm when *Load Mode* is 1 (constant-power) and *Load Select* is 4 (*Design Energy* / 5 for constant discharge). The CONTROL\_STATUS [LDMD] bit indicates Impedance Track algorithm using constantpower model when set.

These values should be set based on the battery specification. See the data sheet from the battery manufacturer.

*Default Design Cap* contains the capacity of the pack originally used to generate the CHEMID data and is used along with *Design Capacity* or *Design Energy* to scale data for the Impedance Track algorithm. *Default Design Cap* should not require modification for any specific application.

#### *Data Memory Parameter Descriptions* [www.ti.com](http://www.ti.com)

#### *6.4.2.3.7 Terminate Voltage*



*Terminate Voltage* is used in the Impedance Track algorithm to compute *RemainingCapacity( )*. This is the absolute minimum voltage for end of discharge, where the remaining chemical capacity is assume to be zero.

This register is application dependent. It should be set based on battery cell specification to prevent damage to the cells or the absolute minimum system input voltage, taking into account impedance drop from the PCB traces, FETs, and wires.

#### *6.4.2.3.8 SOCI Delta*



The *SOCI Delta* parameter is active when the SOC\_INT function is activated when *OpConfig[BATLOWEN]* is cleared. In this case, the GPOUT pin generates interrupts with ~1-ms pulse width under various conditions as described in [Table](#page-9-1) 2-1.

#### <span id="page-39-0"></span>*6.4.2.3.9 Taper Rate, Taper Voltage*



*Taper Rate* is used in the Primary Charge Termination Algorithm. *AverageCurrent( )* is integrated over each of the two *Current Taper Window* periods separately and averaged separately to determine two averages (IRateAvg1, IRateAvg2).

The *Taper Voltage* threshold defines the minimum voltage necessary for as a qualifier for detection of charge termination.

Three requirements must be met to qualify for Primary Charge Termination:

- During two consecutive periods of *Current Taper Windows*: IRateAvg1 < *Taper Rate* and IRateAvg2 < *Taper Rate*
- During the same periods: Accumulated change in capacity < *Min Taper Capacity* per *Current Taper Window*
- *Voltage( )* > *Taper Voltage*

When Primary Charge Termination conditions are met, the *Flags( )* [FC] bit is set and [CHG] bit is cleared. Also, if the *OpConfig [RMFCC]* bit is set, then *RemainingCapacity( )* is set equal to *FullChargeCapacity( )*.

#### *6.4.2.3.10 Sleep Current*



When *AverageCurrent( )* is less than *Sleep Current* or greater than (–)*Sleep Current*, the gauge enters SLEEP mode if the feature is enable by setting the *OpConf [SLEEP]* bit.

This setting should be below any normal application currents.

#### *6.4.2.3.11 Voltage at Charge Termination (V at Chg Term)*



*V at Chg Term* is a learned Data Memory parameter as the voltage reading at the full charge taper termination. This voltage is used to calculate DODatEOC.

#### *6.4.2.3.12 Average Current Last Run (Avg I Last Run)*



The gauge logs the current averaged from the beginning to the end of each discharge cycle. It stores this average current from the previous discharge cycle in this register. This register should never need to be modified. It is only updated by the gauge when required.

#### *6.4.2.3.13 Average Power Last Run (Avg P Last Run)*



The gauge logs the power averaged from the beginning to the end of each discharge cycle. It stores this average power from the previous discharge cycle in this register. To get a correct average power reading the gauge continuously multiplies instantaneous current times voltage to get power. It then logs this data to derive the average power. This register should never need to be modified. It is only updated by the gauge when required.

#### *6.4.2.3.14 Pulse Delta Voltage*



The gauge stores the maximum difference of Voltage during short load spikes and normal load, so the Impedance Track algorithm can calculate *RemainingCapacity( )* for pulsed loads. It is added to *Terminate Voltage* for Impedance Track simulations.

*Data Memory Parameter Descriptions* [www.ti.com](http://www.ti.com)

#### <span id="page-41-0"></span>*6.4.3 Ra Table Class*

#### **6.4.3.1 R\_a NVM Subclass 88, R\_a RAM Subclass 89**

#### *6.4.3.1.1 Cell0 R\_a NVM Table*



The Ra Table class has 15 values. The R  $\alpha$  ROM is used to initialize R  $\alpha$  RAM upon gauge reset. Each of these values represents a resistance value normalized at 0°C for the associated Qmax Cell 0 -based SOC grid point as found by the following rules:

For Cell0 Ra M where:

- If  $0 \le M \le 7$ : The data is the resistance normalized at  $0^{\circ}$  for:  $SOC = 100\% - (M \times 11.1\%)$
- If  $8 \le M \le 14$ : The data is the resistance normalized at  $0^{\circ}$  for:  $SOC = 100\% - [77.7\% + (M - 7) \times 3.3\%]$

This gives a profile of resistance throughout the entire SOC profile of the battery cells concentrating more on the values closer to 0%.

#### Normal Setting:

These resistance profiles are used by the gauge for the Impedance Track algorithm. The only reason this data is displayed and accessible is to give the user the ability to update the resistance data on golden image files. This resistance profile description is for information purposes only. It is not intended to give a detailed functional description for the gauge resistance algorithms. It is important to note that this data is in mΩ and is normalized to 0°C. The following are useful observations to note with this data throughout the application development cycle:

- Watch for negative values in the Ra Table class. Negative numbers in profiles should never be anywhere in this class.
- Watch for smooth consistent transitions from one profile grid point value to the next throughout each profile. As the gauge does resistance profile updates, these values should be roughly consistent from one learned update to another without huge jumps in consecutive grid points.

[www.ti.com](http://www.ti.com) *Data Memory Parameter Descriptions*

#### <span id="page-42-0"></span>*6.4.4 Calibration Class*

#### **6.4.4.1 Data Subclass 104**

#### *6.4.4.1.1 Board Offset*



*Board Offset* is the second offset register. Its calibrates all that the *CC Offset* does not calibrate out. This includes board layout, sense resistor and copper trace, and other potential offsets that are external to the fuel gauge.

#### *6.4.4.1.2 Internal Temperature Offset (Int Temp Offset)*



The gauge has a temperature sensor built into the fuel gauge. The *Int Temp Offset* is used for calibrating offset errors in the measurement of the reported *Temperature( )* if a known temperature offset exists between the fuel gauge and the battery cell. The gain of the internal temperature sensor is accurate enough that a calibration for gain is not required.

#### *6.4.4.1.3 Pack V Offset*



This is the offset to calibrate the gauge analog-to-digital converter for cell voltage measurement.

*Pack V Offset* should not require modification by the user. It is modified by the Voltage Calibration function from Calibration mode.

*Data Memory Parameter Descriptions* [www.ti.com](http://www.ti.com)

#### **6.4.4.2 CC Cal Subclass 105**



#### *6.4.4.2.1 (Coulomb Counter Sense Resistor ) CC Offset, CC Gain, CC Delta*

*CC Offset*, *CC Gain*, and *CC Delta* are internal calibration parameters that require no customer changes and provided for debug purposes only.

Two offsets are used for calibrating the offset of the internal coulomb counter, board layout, sense resistor, copper traces, and other offsets from the coulomb counter readings. *CC Offset* is the calibration value that primarily corrects for the offset error of the fuel gauge coulomb counter circuitry. The other offset calibration is *Board Offset* and is described separately. *CC Offset* is a correction for small noise/errors; therefore, to maximize accuracy, it takes about 16 seconds to calibrate the offset. Since it is impractical to do 16-second offset during IC production, the fuel gauge in will periodically perform an *CC Offset* automatic calibration in SLEEP mode. During the automatic calibration the fuel gauge will set the CONTROL\_STATUS[CCA] bit.

*CC Gain* is the gain factor for calibrating sense resistor, trace, and internal coulomb counter errors. It is used in the algorithm that reports *AverageCurrent( )*. *CC Delta* is a fixed constant based on *CC Gain* used to cancel out the time base error.

#### **6.4.4.3 Current Subclass 107**

#### *6.4.4.3.1 Deadband*



The *Deadband* creates a filter window to the reported *AverageCurrent( )* register where the current is reported as 0. Any negative current above this value or any positive current below this value is displayed as 0.

Only a few reasons may require changing the default value:

- 1. If the PCB layout has issues that cause inconsistent board offsets from board to board.
- 2. An extra noisy environment.

#### <span id="page-43-0"></span>*6.4.4.3.2 RDL Tempco*



The *RDL Tempco* parameter represents the temperature coefficient if an integrated sense resistor were in use. Since this gauge uses an external current sense resistor, a value of 0.00000 is the expected value and there is no expected need to modify it.



#### <span id="page-44-0"></span>*6.4.5 Security Class*

#### **6.4.5.1 Codes Subclass 112**

#### *6.4.5.1.1 Sealed to Unsealed, Unsealed to Full Access*



The fuel gauge implements a key-access scheme to transition from SEALED to UNSEALED mode. Once SEALED via the associated subcommand, a unique set of two keys must be sent to the fuel gauge via the *Control( )* command to return to UNSEALED mode. The keys must be sent consecutively, with no other data being written to the *Control( )* register in between.

When in the SEALED mode, the CONTROL\_STATUS [SS] bit is set; but when the *Sealed to Unsealed* keys are correctly received by the fuel gauge, the [SS] bit is cleared. The *Sealed to Unsealed* key has two identical words stored in ROM with a value of 0x80008000. Then *Control( )* should supply 0x8000 and 0x8000 (again) to unseal the part.

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